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APPLICATION NO.	F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/452,691		12/02/1999	FRED D. BAILEY	TI-27935	1638
23494	7590	03/15/2002			
		ENTS INCORPO	EXAMINER		
P O BOX 6 DALLAS, 7			FENTY, JESSE A		
DALLAS,	17203	,			
				ART UNIT	PAPER NUMBER
•				2815	
			DATE MAILED: 03/15/2002		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)				
	Office Action O	09/452,691	BAILEY ET AL.				
	Office Action Summary	Examiner	Art Unit				
		Jesse A. Fenty	2815				
Period fo	Th MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b). Status							
1)🖂	1) Responsive to communication(s) filed on 11/01/01						
2a)⊠	This action is FINAL . 2b) Thi	s action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. Disposition of Claims							
4) Claim(s) 1-8 is/are pending in the application.							
4a) Of the above claim(s) is/are withdrawn from consideration.							
5)	5) Claim(s) is/are allowed.						
	6)⊠ Claim(s) <u>1-8</u> is/are rejected.						
7)	7) Claim(s) is/are objected to.						
l l	8) Claim(s) are subject to restriction and/or election requirement. Application Papers						
9) 🗌 7	9)☐ The specification is objected to by the Examiner.						
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
11)☐ The proposed drawing correction filed on is: a)☐ approved b)☐ disapproved by the Examiner.							
If approved, corrected drawings are required in reply to this Office action.							
12)☐ The oath or declaration is objected to by the Examiner.							
Priority under 35 U.S.C. §§ 119 and 120							
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).							
a)[a) ☐ All b) ☐ Some * c) ☐ None of:						
	1. Certified copies of the priority documents have been received.						
:	2. Certified copies of the priority documents have been received in Application No						
ĺ	 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
14)□ A	14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).						
a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.							
Attachment(s)							
2) Notice 3) Inform	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) ation Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Informal F	(PTO-413) Paper No(s) Patent Application (PTO-152)				
U.S. Patent and Train PTO-326 (Rev.		on Summary	Part of Paper No. 9				

Art Unit: 2815

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.
- 2. Claims 1, 2, 6 and 7 are rejected under 35 U.S.C. 102(e) as being anticipated by Saia et al. (U.S. Patent No. 5,874,770).

In re claim 1, Saia (Figs. 5, 12) discloses an integrated circuit comprising:

A lower metal interconnect layer (22) located over a semiconductor body,

A multi-level dielectric layer (10, 40, 54) located over said lower interconnect layer;

An upper metal interconnect layer (21) located over said multi-level dielectric layer; and

A thin-film resistor (16, 18) located within said multi-level dielectric layer between said lower metal interconnect layer and said upper metal interconnect layer.

In re claim 2, Saia discloses the device of claim 1, further comprising:

A first plurality of conductively filled vias (47) extending from said upper metal interconnect layer to said lower interconnect layer; and

A second plurality of conductively filled vias (34) extending from said upper metal layer to said thin film resistor.

Art Unit: 2815

In re claim 6, Saia discloses the device of claim 1, wherein said thin film resistor structure comprises TaN.

In re claim 7, Saia discloses the device of claim 1, wherein said thin film resistor structure comprises SiCr.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claim 3 is rejected under 35 U.S.C. 103(a) as being unpatentable over Saia et al. (as above).

In re claim 3, Saia discloses the device of claim 1, wherein said thin film resistor comprises a top plate which can be used as a hard mask (MacElwee; column 7, lines 48-51). Although MacElwee cites using polysilicon as electrode material, it is well known to those skilled in this art that polysilicon and metal electrodes (in this case, copper) are interchangeable in the art and it would have been obvious for one skilled in the art at the time of the invention to choose select an appropriate conductive layer for a given device based on that knowledge.

5. Claims 4, 5 and 8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Saia et al. as applied to claim 1 above, and further in view of Linn et al. (U.S. Patent No. 5,547,896).

Art Unit: 2815

In re claims 4 and 5, Saia discloses the device of claim 3, wherein the resistor comprises chromium silicide (column 5, line 9) with a masking layer but does not expressly disclose a "hard mask" layer comprising TiW or TiN. Linn et al. (Figs. 1a-3b) discloses an electrode of the same material overlaid by a TiW or TiN "hard mask." It would have been obvious to one skilled in the art at the time of the invention to use a hard mask as taught by Linn to overlay the chromium electrode of Saia for the purpose, for example, of cleanly etching a chromium alloy resistor such that residual contaminants will not compromise the integrity of the chromium resistor (Linn; column 1, lines 60-66; column 2, lines 26-30).

In re claim 8, Saia discloses the device of claim 3, but does not expressly disclose the resistor comprising NiCr. Linn discloses the interchangeability between SiCr and NiCr and it would have been obvious for one skilled in the art to make a material choice based on similarities of known materials.

Response to Arguments

1. Applicant's arguments filed 11/01/01 have been fully considered but they are not persuasive.

Applicant argues that the thin film resistor structure is not anticipated by Saia. Mainly that the "resistors (28) are not part of the integrated circuit (44).

The application claims an IC comprising a lower interconnect over a semiconductor body, wherein the lower interconnect has a multi-layer dielectric layer over it and a thin film resistor located within the multi-layer dielectric. This structure is analogous to the structure disclosed by Saia which clearly discloses a lower interconnect (22) over a semiconductor body

Art Unit: 2815

(45), a multi-layer dielectric layer over it and a thin film resistor located within the multi-layer dielectric as described in the body of the rejection.

Applicant argues that the integrated circuit (44) of Saia does not comprise the thin film resistors (28) as required by the claim. However, the claims do not claim that the resistors be imbedded in the substrate, which would have to be the case for the region (44) to comprise the resistors. Rather, the claims state that the interconnects, dielectric and resistor lay within the integrated circuit, which comprises the entire device of Fig. 12, including the layers above and below the surface of the substrate (45).

Conclusion

2. THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Page 6

Application/Control Number: 09/452,691

Art Unit: 2815

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jesse A. Fenty whose telephone number is 703-308-8137. The examiner can normally be reached on 5/4-9 1st Fri. Off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie Lee can be reached on 703-308-1690. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7722 for regular communications and 703-746-3892 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

Jesse A. Fenty Examiner Art Unit 2815

EDDIE LEE SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800